

ED-US030115

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of :  
 :  
 Ikuo MURATA :  
 :  
 Serial No.: New (PCT/JP2004/014195) :  
 :  
 Filed: Herewith :  
 :  
 For: METHOD FOR MANUFACTURING A :  
 ROTARY MEMBER OF A TORQUE :  
 CONVERTER AND A ROTARY :  
 MEMBER OF A TORQUE CONVERTER :  
 MANUFACTURED BY THE METHOD :  
 (AS AMENDED) :

**INFORMATION DISCLOSURE STATEMENT**

Assistant Commissioner of Patents  
 Washington, DC 20231

Sir:

In accordance with MPEP 609 and 37 C.F.R. §§ 1.56, 1.97 and 1.98, Applicant brings the attached references to the Examiner's attention and requests that they be considered and made of record in this application. Also attached is a completed PTO-1449 form. This Information Disclosure Statement is being filed within three (3) months of the filing date of this application. Thus, *no fee is believed to be due for this Information Disclosure Statement*. However, the Commissioner is authorized to charge any fees associated with this communication or credit any overpayment to Deposit Account No. 50-1836. A duplicate copy of this Statement is enclosed for that purpose.

Since International Application No. PCT/ JP2004/014195 entered the national stage under 35 U.S.C. 371 after June 30, 2003 (when this U.S. application was filed), the U.S. Patent and Trademark Office waives the requirement under 37 C.F.R. 1.98(a)(2)(i) for submitting a copy of each cited U.S. patent and each U.S. patent application publication.

A copy of International Search Report of International Application No. PCT/ JP2004/014195 is attached hereto.

ALL REFERENCES CONSIDERED EXCEPT WHERE LINED THROUGH. /RC/

Serial No.: New-Nat'l phase of  
PCT/ JP2004/014195  
International filing date: 09/29/2004

10/576775  
10576775 - GAU: 3726  
IP12 Rec'd PCT/PTO 21 APR 2006

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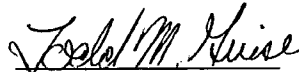
Japanese Laid-Open Patent Publication No. JP-S45-23408 appears to disclose a method for bonding vanes in a torque converter. U.S. Patent No. 3,673,659 is the U.S. counterpart of JP-S45-23408, and is cited in lieu of a translation.

Japanese Laid-Open Patent Publication No. JP-S61-140364 appears to disclose a method for brazing blades of sheet metal. An English language translation of the Abstract is provided herewith.

\* \* \*

Prompt examination on the merits is respectfully requested.

Respectfully submitted,



Todd M. Guise  
Reg. No. 46,748

SHINJYU GLOBAL IP COUNSELORS, LLP  
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Dated: 4/21/06  
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## Substitute for form 1449A/PTO

(use as many sheets as necessary)

Sheet	1	of	1
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**Complete if Known**

Application Number	New
Filing Date	Herewith
First Named Inventor	Ikuo MURATA
Group Art Unit	
Examiner Name	
Attorney Docket Number	ED-US030115

## U.S. PATENT DOCUMENTS

[illegible]

## FOREIGN PATENT DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T <sup>6</sup>
		Country Code <sup>3</sup> - Number <sup>4</sup> - Kind Code <sup>5</sup> (if known)				
		JP-S45-23408-B1	08-06-1970	ISHII et al.	full text	NO
		JP-S61-140364-A	06-27-1986	ITO et al.	page 3, upper left column, lines 5 -19	NO
		JP-H05-71611-A	03-23-1993	YOSHIDA et al.	Paragraphs 0021 - 0033	YES
		JP-H05-71612-A	03-23-1993	OKUBO et al.	Fig. 1	YES
		JP-H10-26208-A	01-27-1998	MATSUMOTO et al.	full text	YES

**Examiner  
Signature**

/Rick Chang/

Date  
Considered

06/06/2010

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup> Applicant's unique citation designation number (optional). <sup>2</sup> See Kinds Codes of USPTO Patent Documents at [www.uspto.gov](http://www.uspto.gov) or MPEP 901.04.

<sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Translation is attached.

**Burden Hour Statement:** This form is estimated to take 2.0 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. **DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO:** Assistant Commissioner for Patents, Washington, DC 20231.

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